

Technical Data Sheet

MODEL NO: S190ANG4

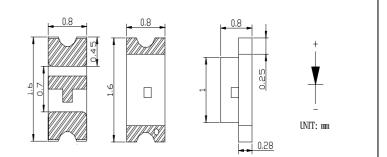
0603Package 1.6*0.8mm Chip LEDs

Features:

- Package in 8mm tape on 7" diameter reel
- Compatible with automatic placement equipment
- Compatible with reflow solder process

Applications:

- Indicators
- Automotive: backlighting in dashboard and switch
- Backlight for LCD



Dice material	Emitted color	Lens Color
InGaN	Green	Water Clear

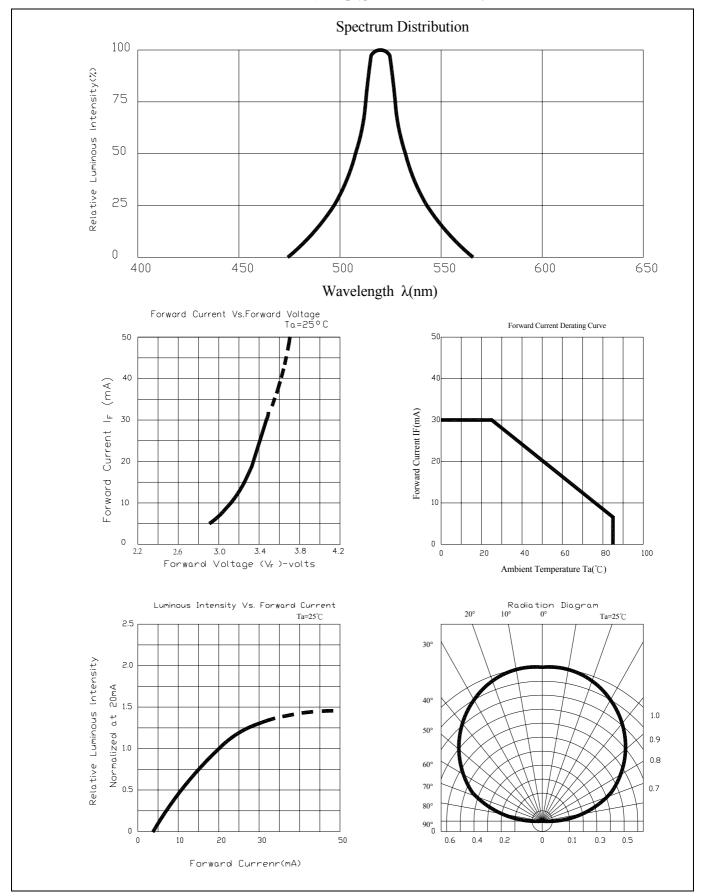
Electrical/Optical Characteristics(Ta=25°C)

Parameter	Symbo1	Condition	Min	Typ.	Max	Unit
Luminous Internisity	Iv	IF=20mA	115	200		mcd
Dominant Wavelength	λD	IF=20mA		530		nm
Peak Emission Wavelength	λр	IF=20mA		530		nm
Viewing Angle	2 🖯 1 / 2	IF=20mA		130		Deg
Forward Voltage	VF	IF=20mA		3. 2	3.5	V
Reverse Current	IR	VR=5V			10	μA

Absolute Maximum Ratings(Ta=25°C)

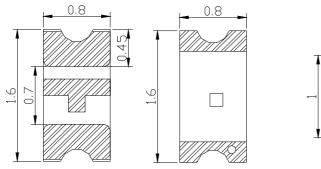
Parameter	Symbol	Maximum	Unit
Power Dissipation	Pd	78	mW
Peak Forward Current(1/10 Duty Cycle 0.1ms Pulse Width)	IF(Peak)	100	mA
Continuous Forward Current	IF	30	mA
Reverse Voltage	VR	5	V
Derating Linear From 25°C		0.3	mA/°C
Operating Temperature Range	Topr	-30 to +80	$^{\circ}\! C$
Storage Temperature Range	Tstg	-40 to +90	$^{\circ}\! C$

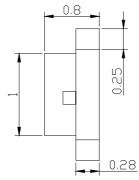






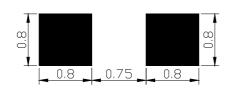
Package Dimensions







Paecommended Soldering Pattern

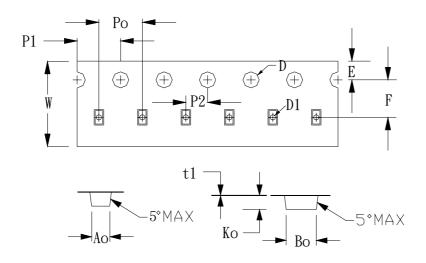


UNIT: mm

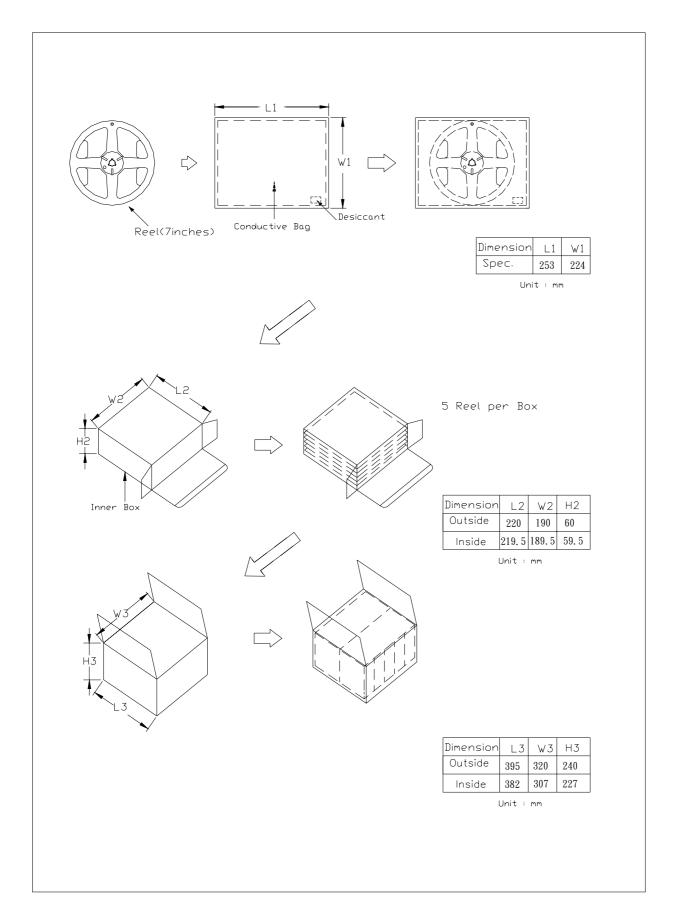
● Tape Specification : 4000pcs Per Reel

Packing Size													
Item	W	P1	Е	F	Do	D1	Ро	10Po	P2	Ao	Во	Ко	t
Spec.	8.00	4.00	1.75	3.50	1.50	0.5	4.00	40.00	2.00	0.90	1.75	0.70	0.23
Tolerance	±0.20	±0.10	±0.10	±0.05	+0.10 -0.00	±0.05	±0.05	±0.20	±0.05	±0.10	±0.10	±0.10	±0.05

● Tape Specifications







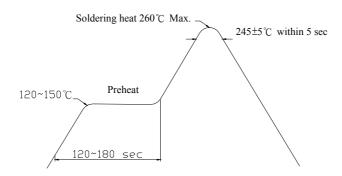


Descriptions:

- The Chip-LED Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature application, etc.

Soldering heat reliability (DIP):

Please refer to the following figure:



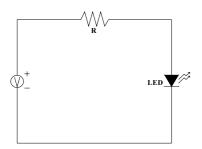
Precautions For Use :

Over - current - proof
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

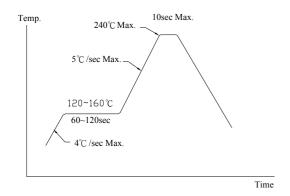
- Storage
- 1. The operation of temperature and R.H. are : 5° C $\sim 30^{\circ}$ C, 60%R.H. Max..
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
- 3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is : $60^{\circ}\text{C}\pm5^{\circ}\text{C}$ for 15hrs.



● Test Circuit



Reflow Temp. / Time :



Reliability Test Items And Conditions

The reliability of products shal be satisfied with items listed below.

No.	Items	Test Condition	Test Hours/Cycles	Sample Size
1	Solder Heat	TEMP: 260°C±5°C	5 sec	48 pcs
2	Temperature Cycle	90°C ~ 25°C ~ -30°C ~ 25°C 30m 5m 30m 5m	300Cycles	48 Pcs
3	Thermal Shick	100°C ~ -55°C 10m 10m	100Cycles	48 Pcs
4	Operation Life	If=20mA	1000 Hrs	48 Pcs
5	High Temperature Storage	Temp:90°C	1000Hrs	48 Pcs
6	Low Temperature Storage	Temp:-30°C	1000Hrs	48 Pcs
7	High Temperature/High Humidity	80°C / R.H80%	1000Hrs	48 Pcs